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N-Channel PowerTrench[®] SyncFETTM 30 V, 42 A, 4.9 m Ω

Features

- Max $r_{DS(on)}$ = 4.9 m Ω at V_{GS} = 10 V, I_D = 18 A
- Max r_{DS(on)} = 5.8 mΩ at V_{GS} = 4.5 V, I_D = 14 A
- Advanced Package and Silicon combination for low r_{DS(on)} and high efficiency
- SyncFET Schottky Body Diode
- MSL1 robust package design
- 100% UIL tested
- RoHS Compliant

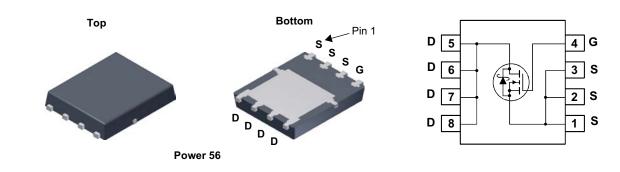


General Description

The FDMS0312S has been designed to minimize losses in power conversion application. Advancements in both silicon and package technologies have been combined to offer the lowest $r_{DS(on)}$ while maintaining excellent switching performance. This device has the added benefit of an efficient monolithic Schottky body diode.

Applications

- Synchronous Rectifier for DC/DC Converters
- Notebook Vcore/ GPU low side switch
- Networking Point of Load low side switch
- Desktop



MOSFET Maximum Ratings T_A = 25 °C unless otherwise noted

Symbol	Parameter			Ratings	Units	
V _{DS}	Drain to Source Voltage			30	V	
V _{GS}	Gate to Source Voltage		(Note 4)	±20	V	
ID	Drain Current -Continuous (Package limited)	T _C = 25 °C		42		
	-Continuous (Silicon limited)	T _C = 25 °C		83	- A	
	-Continuous	T _A = 25 °C	(Note 1a)	19		
	-Pulsed			90		
E _{AS}	Single Pulse Avalanche Energy		(Note 3)	60	mJ	
P _D	Power Dissipation	T _C = 25 °C		46	w	
	Power Dissipation	T _A = 25 °C	(Note 1a)	2.5	VV	
T _J , T _{STG}	Operating and Storage Junction Temperature Range			-55 to +150	°C	
Thermal Ch	naracteristics		ľ		·	
Role	Thermal Resistance, Junction to Case			2.7		

R _{0JA} Thermal Resistance, Junction to Ambient(Note 1a)50	°C/W

Package Marking and Ordering Information

[Device Marking	Device	Package	Reel Size	Tape Width	Quantity
[FDMS0312S	FDMS0312S	Power 56	3 "	12 mm	3000 units

October 2014

FDMS0312S
N-Channel I
owerTrench [®]
[®] SyncFET TM

Oymbol	T di diffetet	Test conditions		- IJP	IIIuA	0
Off Chara	acteristics					
BV _{DSS}	Drain to Source Breakdown Voltage	I _D = 1 mA, V _{GS} = 0 V	30			V
$\frac{\Delta BV_{DSS}}{\Delta T_{J}}$	Breakdown Voltage Temperature Coefficient	$I_D = 10$ mA, referenced to 25 °C		18		mV/°C
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} = 24 V, V _{GS} = 0 V			500	μA
I _{GSS}	Gate to Source Leakage Current, Forward	$V_{GS} = 20 \text{ V}, V_{DS} = 0 \text{ V}$			100	nA
		00 200				
	acteristics (Note 2)		1.0	10	2.0	
V _{GS(th)}	Gate to Source Threshold Voltage	$V_{GS} = V_{DS}, I_D = 1 \text{ mA}$	1.2	1.9	3.0	V
$rac{\Delta V_{GS(th)}}{\Delta T_J}$	Gate to Source Threshold Voltage Temperature Coefficient	I_D = 10 mA, referenced to 25 °C		-5		mV/°C
		V _{GS} = 10 V, I _D = 18 A		3.6	4.9	4
r _{DS(on)}	Static Drain to Source On Resistance	V _{GS} = 4.5 V, I _D = 14 A		4.7	5.8	mΩ
		V _{GS} = 10 V, I _D = 18 A, T _J = 125 °C		5	6.2	
9 _{FS}	Forward Transconductance	V _{DS} = 5 V, I _D = 18 A		97		S
Dvnamic	Characteristics					
C _{iss}	Input Capacitance			2120	2820	pF
C _{oss}	Output Capacitance	$V_{DS} = 15 V, V_{GS} = 0 V,$		735	975	pF
C _{rss}	Reverse Transfer Capacitance	f = 1 MHz		90	135	pF
R _q	Gate Resistance			1.1	2.2	Ω
U						
	g Characteristics	1				1
t _{d(on)}	Turn-On Delay Time	-		12	21	ns
t _r	Rise Time	V _{DD} = 15 V, I _D = 18 A,		5	10	ns
t _{d(off)}	Turn-Off Delay Time	_V _{GS} = 10 V, R _{GEN} = 6 Ω		28	44	ns
t _f	Fall Time			4	10	ns
Q _g	Total Gate Charge	V _{GS} = 0 V to 10 V		33	46	nC
Q _g	Total Gate Charge	$V_{GS} = 0 V \text{ to } 4.5 V V_{DD} = 15 V,$		15	22	nC
Q _{gs}	Gate to Source Gate Charge	I _D = 18 A		6.5		nC
Q _{gd}	Gate to Drain "Miller" Charge			4.0		nC
Drain-So	urce Diode Characteristics					
		$V_{GS} = 0 V, I_S = 2 A$ (Note 2)		0.48	0.7	
V _{SD}	Source to Drain Diode Forward Voltage			0.80	1.2	V
trr	Reverse Recovery Time					ns
		I _F = 18 A, di/dt = 300 A/μs				nC
t _{rr} Q _{rr} Notes:	Reverse Recovery Time Reverse Recovery Charge nined with the device mounted on a 1in ² pad 2 oz copper pad	unted on a	b. 125 °C/	0.80 26 26 by design wh W when mou m pad of 2 o	unted on a	ns
		00000				

Test Conditions

Min

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Max

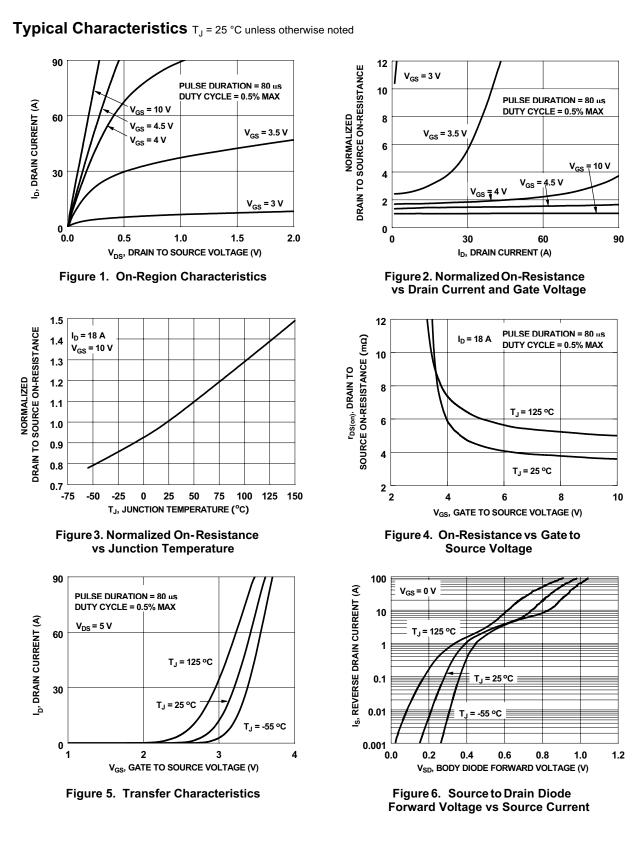
Units

4. As an N-ch device, the negative Vgs rating is for low duty cycle pulse occurrence only. No continuous rating is implied.

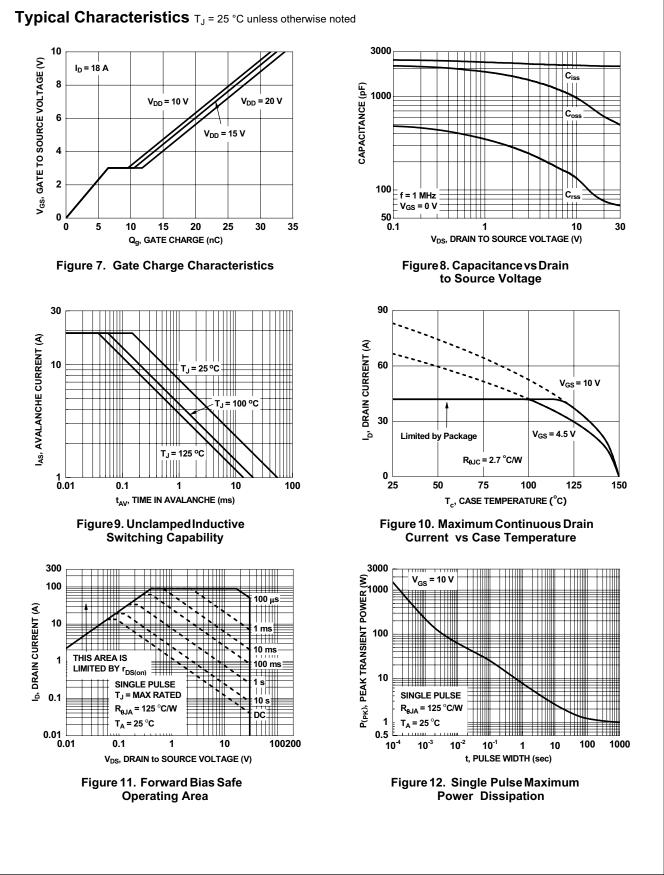
Electrical Characteristics T_J = 25 °C unless otherwise noted

Parameter

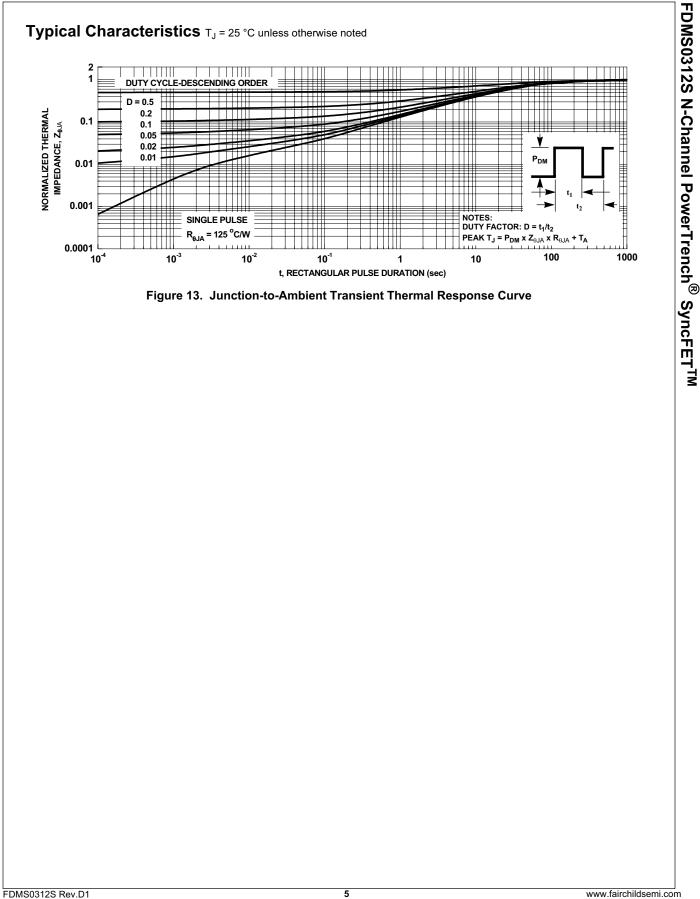
Symbol



FDMS0312S Rev.D1



FDMS0312S N-Channel PowerTrench[®] SyncFETTM



FDMS0312S N-Channel PowerTrench[®] SyncFETTM

Typical Characteristics (continued)

SyncFET Schottky body diode Characteristics

Fairchild's SyncFET process embeds a Schottky diode in parallel with PowerTrench MoSFET. This diode exhibits similar characteristics to a discrete external Schottky diode in parallel with a MOSFET. Figure 14 shows the reverses recovery characteristic of the FDMS0312S.

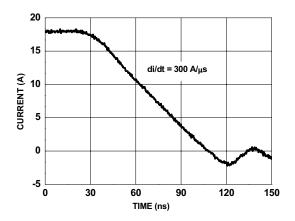
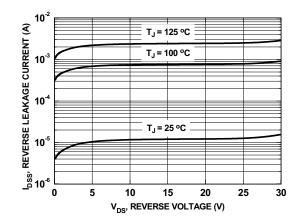
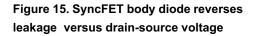
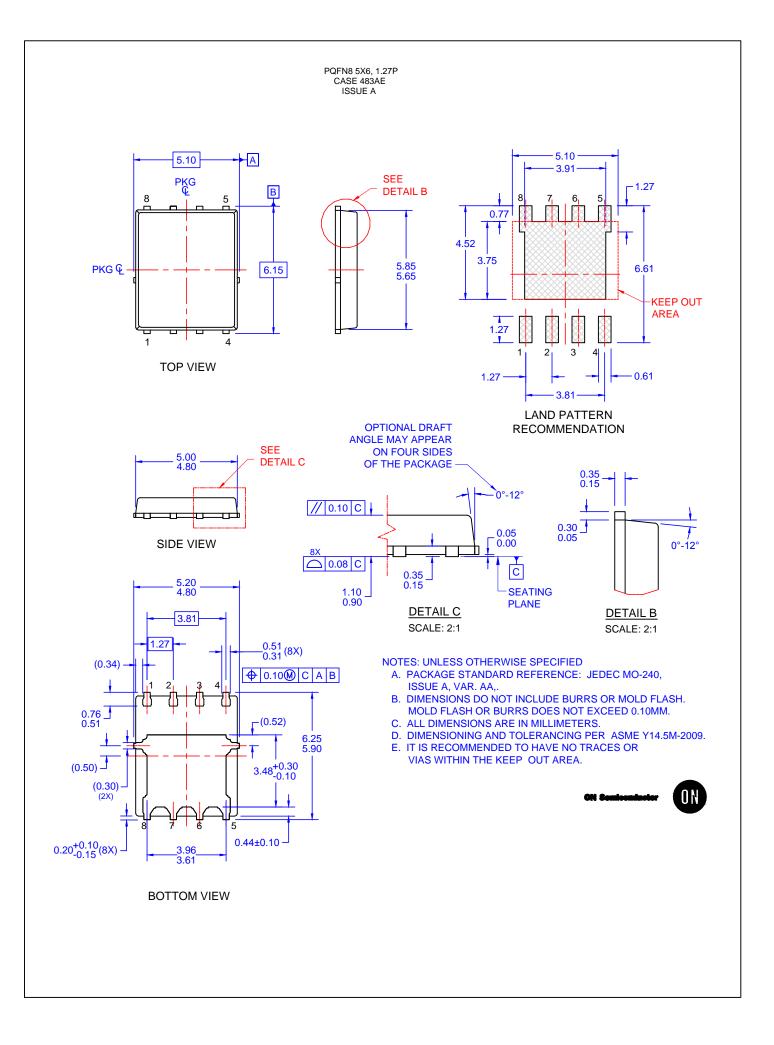


Figure 14. FDMS0312S SyncFET body diode reverse recovery characteristic

Schottky barrier diodes exhibit significant leakage at high temperature and high reverse voltage. This will increase the power in the device.







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